

Electronic Patent Application Fee Transmittal

Application Number:	10591476			
Filing Date:	01-Sep-2006			
Title of Invention:	Copper film deposition method			
First Named Inventor/Applicant Name:	Yasuhiko Kojima			
Filer:	Michael A. Makuch/Cynthia Johnson			
Attorney Docket Number:	33082M343			

Filed as Large Entity

U.S. National Stage under 35 USC 371 Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Basic Filing:

Pages:

Claims:

Miscellaneous-Filing:

Petition:

Patent-Appeals-and-Interference:

Post-Allowance-and-Post-Issuance:

Extension-of-Time:

Extension - 1 month with \$0 paid	1251	1	150	150
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				150